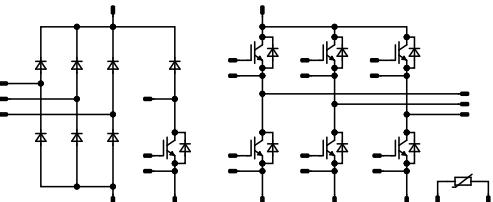




Vincotech

flowPIM S3		1200 V / 100 A
Features	flow S3 12 mm housing	
<ul style="list-style-type: none">• IGBT M7 with low VCEsat and improved EMC behavior• New low inductive package• Enhanced thermal performance		
Target applications	Schematic	
<ul style="list-style-type: none">• Embedded Drives• Industrial Drives		
Types		
<ul style="list-style-type: none">• B0-SP12PMA100M7-LQ99A78T		



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	109	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	205	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150^\circ\text{C}$	9,5	μs
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	77	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	139	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
Brake Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	90	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	176	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Brake Diode				
Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	32	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	50	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	60	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Brake Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	13	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	10	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	32	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Rectifier Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	110	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$	890	A
Surge current capability	I_{st}	$T_j = 150^\circ\text{C}$	3960	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	125	W
Maximum junction temperature	T_{jmax}		150	$^\circ\text{C}$



Vincotech

Maximum Ratings

$T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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Module Properties

Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				>12,7	mm
Clearance				7,88	mm
Comparative Tracking Index	CTI			≥ 600	

*100 % tested in production



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$			10	0,01	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		100	25 125 150		1,53 1,71 1,75	1,85 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			100	μA
Gate-emitter leakage current	I_{GES}		20	0		25			0,5	μA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{res}		0	10	25			21000		pF
Output capacitance	C_{des}							700		pF
Reverse transfer capacitance	C_{res}							280		pF
Gate charge	Q_g	$V_{CC} = 600$ V	15		100	25		700		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,46		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	± 15	600	100	25		177,92		
Rise time	t_r					125		176,32		ns
						150		176		
Turn-off delay time	$t_{d(off)}$					25		27,52		
						125		31,36		
Fall time	t_f					150		32,64		ns
Turn-on energy (per pulse)	E_{on}					25		188,8		
		$Q_{fFWD}=10,29 \mu C$				125		216,96		
		$Q_{fFWD}=15,31 \mu C$				150		223,36		
Turn-off energy (per pulse)	E_{off}	$Q_{fFWD}=17,47 \mu C$				25		75,98		
						125		102,53		
						150		107,42		ns
						25		5,03		
						125		6,96		mWs
						150		7,58		
						25		7,05		
						125		9,74		mWs
						150		10,56		



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Inverter Diode

Static

Forward voltage	V_F				100	25 125 150		1,82 1,96 1,97	2,1 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V			25			40	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,68		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=4096$ A/ μ s $di/dt=3530$ A/ μ s $di/dt=3376$ A/ μ s	± 15	600	100	25 125 150		135,5 136,84 137,89		A
Reverse recovery time	t_{rr}					25 125 150		220,6 355,08 403,89		ns
Recovered charge	Q_r					25 125 150		10,29 15,31 17,47		μ C
Reverse recovered energy	E_{rec}		± 15	600	100	25 125 150		4,4 6,57 7,55		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		3148 2497 2218		A/ μ s



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Brake Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$			10	0,0075	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		75	25 125 150		1,55 1,7 1,75	1,9 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			100	µA
Gate-emitter leakage current	I_{GES}		20	0		25			500	nA
Internal gate resistance	r_g							4		Ω
Input capacitance	C_{res}		0	10	25			16000		pF
Output capacitance	C_{des}							480		pF
Reverse transfer capacitance	C_{res}							190		pF
Gate charge	Q_g	$V_{CC} = 600$ V	15		75	25		570		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,54		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/15	700	55	25		111,68		
Rise time	t_r					125		108,8		
						150		107,84		ns
Turn-off delay time	$t_{d(off)}$					25		38,72		
						125		45,44		
						150		47,36		ns
Fall time	t_f					25		442,56		
Turn-on energy (per pulse)	E_{on}	$Q_{fFWD}=3,6 \mu C$ $Q_{fFWD}=5,52 \mu C$ $Q_{fFWD}=6,16 \mu C$				125		515,84		
						150		535,68		ns
Turn-off energy (per pulse)	E_{off}					25		95,69		
						125		135,6		ns
						150		143,58		
						25		4,26		mWs
						125		5,31		
						150		5,56		
						25		5,37		mWs
						125		7,79		
						150		8,19		



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Brake Diode

Static

Forward voltage	V_F				25	25 125 150		1,63 1,7 1,69	2,1 ⁽¹⁾	V
Reverse leakage current	I_R	$V_F = 1200$ V			25			35	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						1,58		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=1318$ A/ μ s $di/dt=1118$ A/ μ s $di/dt=1105$ A/ μ s	0/15	700	55	25		32,72		
Reverse recovery time	t_{rr}					125		34,34		
Recovered charge	Q_r					150		35,03		A
Recovered charge	Q_r		25	125	150			256,31		
Reverse recovered energy	E_{rec}							380,02		ns
Reverse recovered energy	E_{rec}							423,75		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		25					3,6		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		125					5,52		μ C
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		150					6,16		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		25					1,56		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		125					2,59		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		150					2,94		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		25					206,58		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		125					227,2		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		150					225,17		A/μ s



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Brake Sw. Protection Diode

Static

Forward voltage	V_F				5	25 125 150		1,57 1,66 1,65	2,1 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25			20	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						2,92		K/W
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Rectifier Diode

Static

Forward voltage	V_F				60	25 125 150		1,04 0,973 0,956	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 2	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,56		K/W
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Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

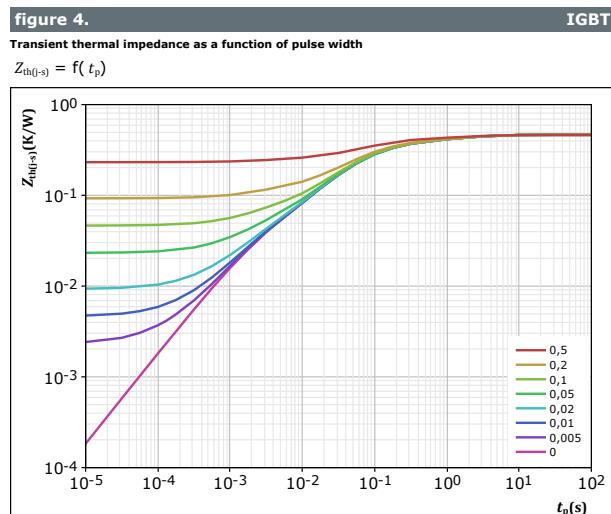
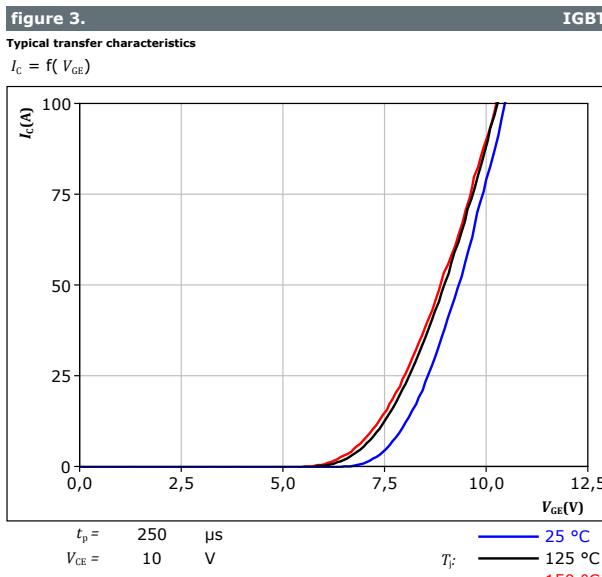
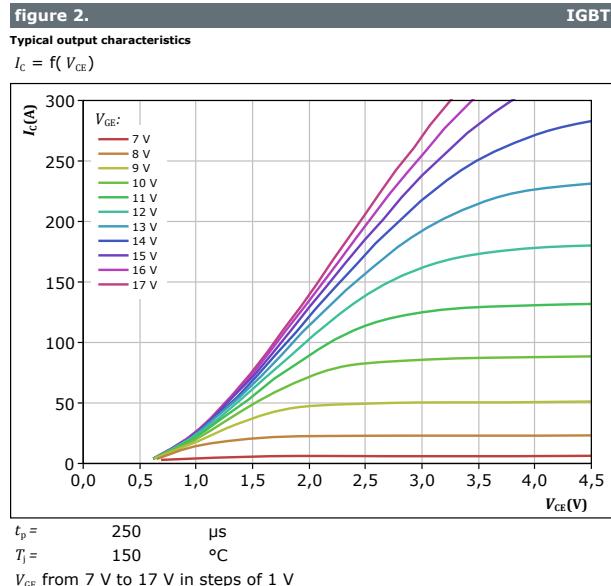
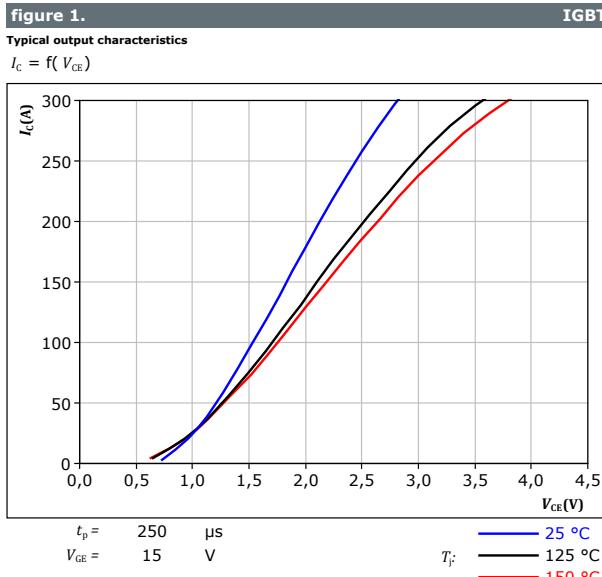
(¹) Value at chip level

(²) Only valid with pre-applied Vincotech thermal interface material.



Vincotech

Inverter Switch Characteristics



IGBT thermal model values		
R (K/W)	τ (s)	
5,07E-02	2,79E+00	
7,33E-02	5,73E-01	
1,97E-01	9,12E-02	
1,18E-01	2,74E-02	
2,48E-02	2,11E-03	



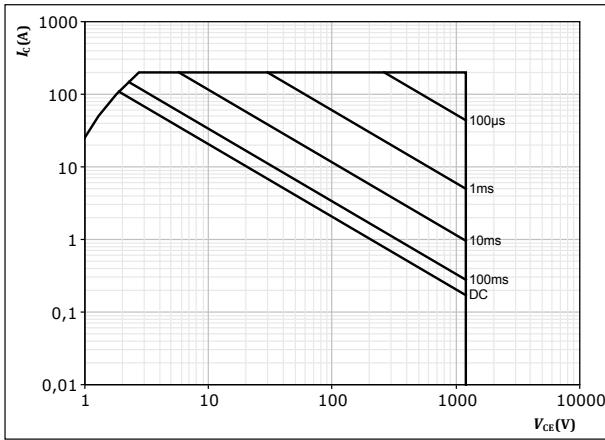
Vincotech

Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse

$T_s = 80^\circ\text{C}$

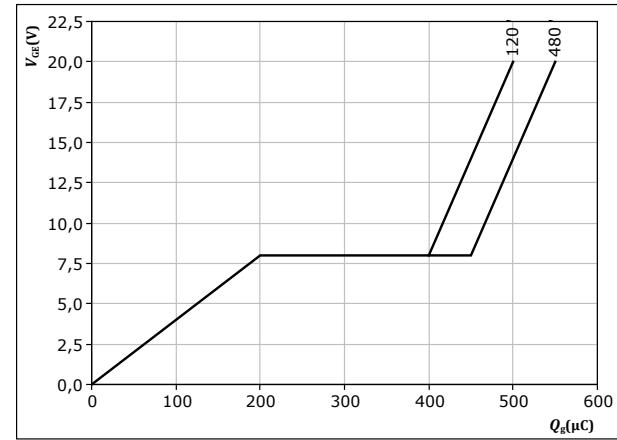
$V_{GE} = 15 \text{ V}$

$T_j = T_{j\max}$

figure 6. IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$



$I_C = \dots$

$T_j = 25^\circ\text{C}$



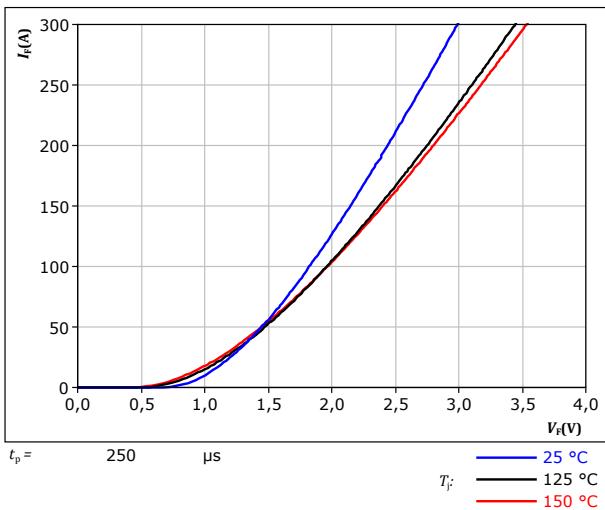
Inverter Diode Characteristics

figure 7.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

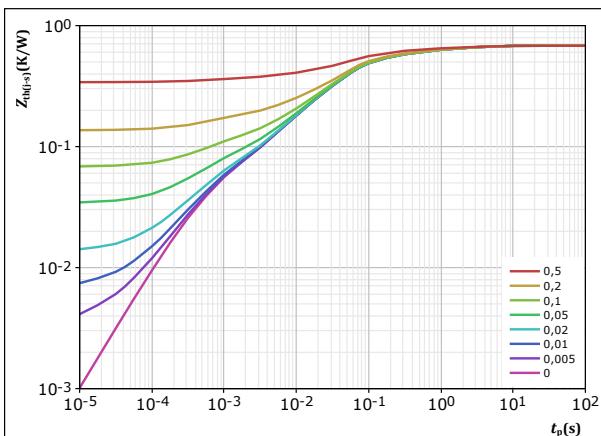
$T_J:$
— 25 °C
— 125 °C
— 150 °C

figure 8.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T} = 0,681 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	τ (s)
6,44E-02	2,44E+00
1,07E-01	3,59E-01
3,84E-01	4,92E-02
8,35E-02	7,03E-03
4,34E-02	5,30E-04



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Brake Switch Characteristics

figure 9. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

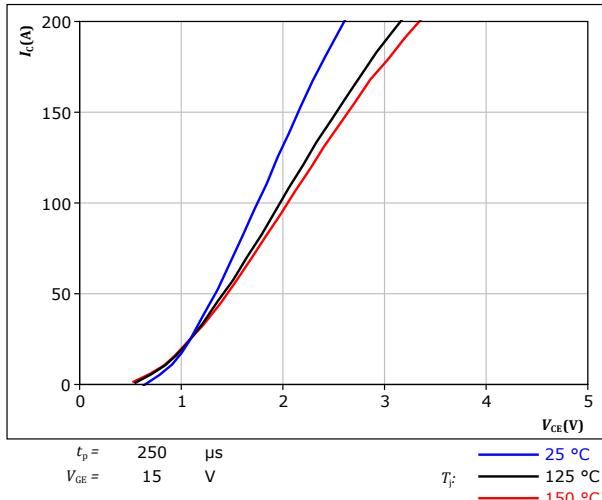


figure 10. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

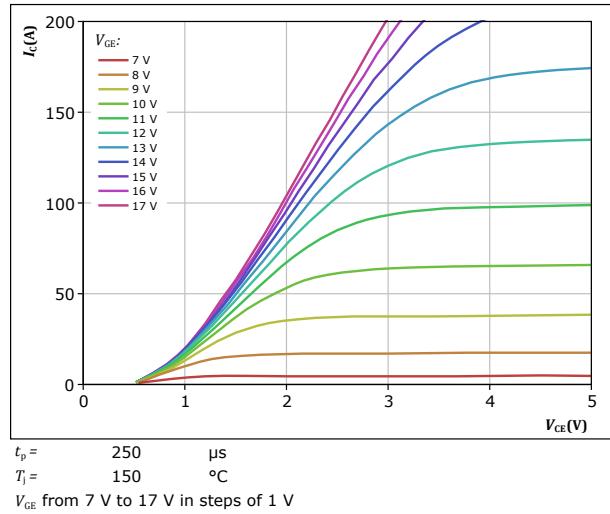


figure 11. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

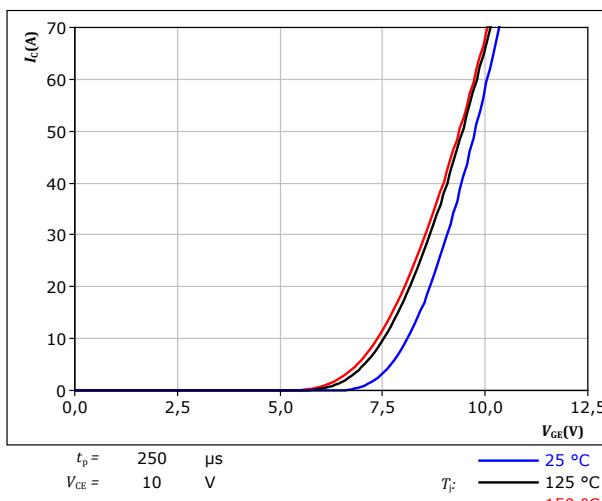
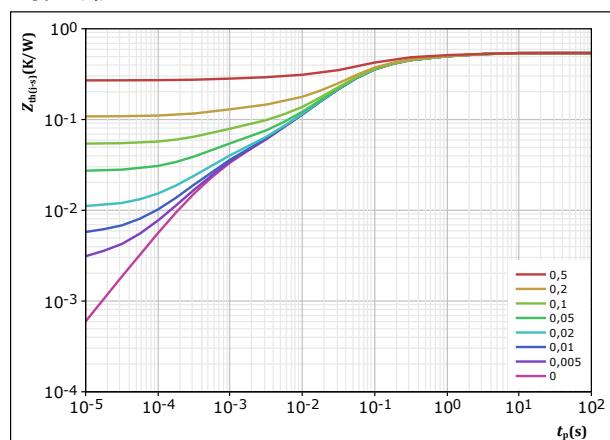


figure 12. IGBT

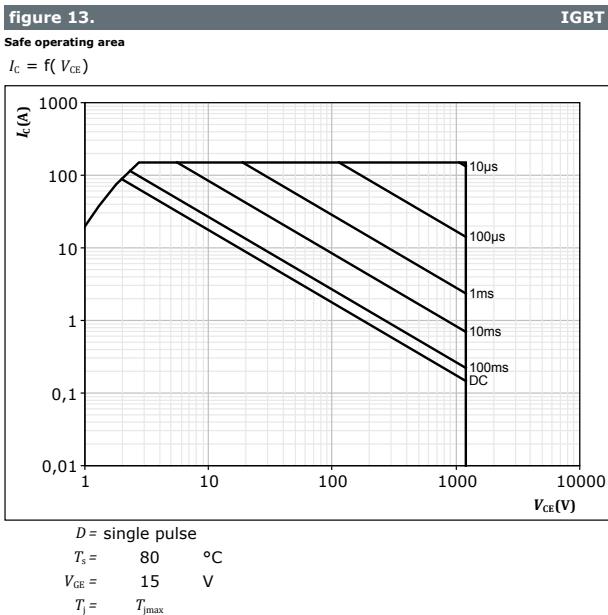
Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$



$R_{th(j-s)}$	t_p / T	K/W
IGBT thermal model values		
R (K/W)	τ (s)	
5,00E-02	2,48E+00	
7,47E-02	4,69E-01	
2,01E-01	9,12E-02	
1,65E-01	3,27E-02	
2,53E-02	4,04E-03	
2,43E-02	5,25E-04	



Brake Switch Characteristics





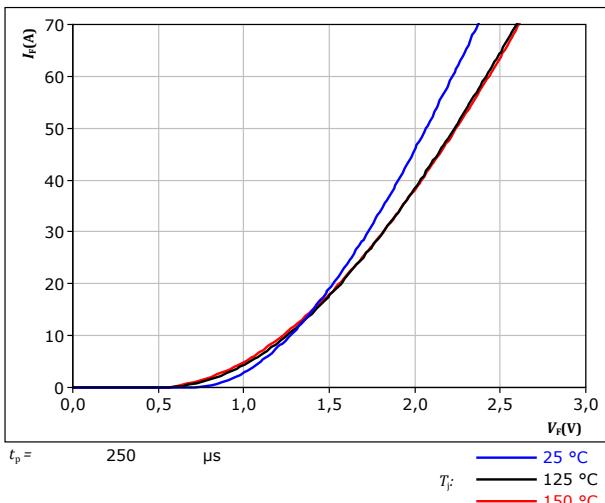
Brake Diode Characteristics

figure 14.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

$$T_F:$$

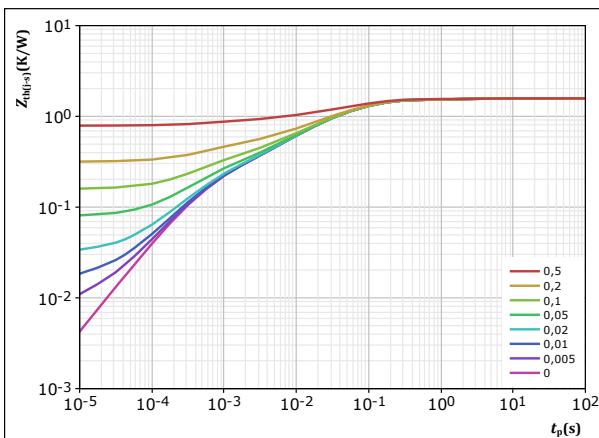
- 25 °C
- 125 °C
- 150 °C

figure 15.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T} = 1,578 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	τ (s)
6,04E-02	2,69E+00
5,84E-01	9,86E-02
5,77E-01	2,18E-02
1,94E-01	3,61E-03
1,63E-01	4,75E-04



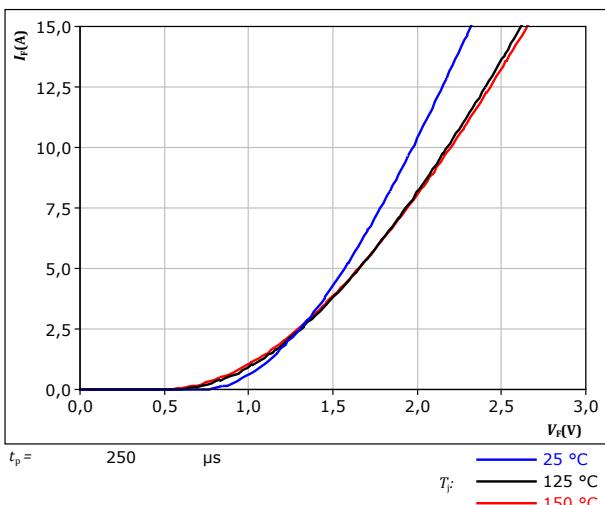
Brake Sw. Protection Diode Characteristics

figure 16.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

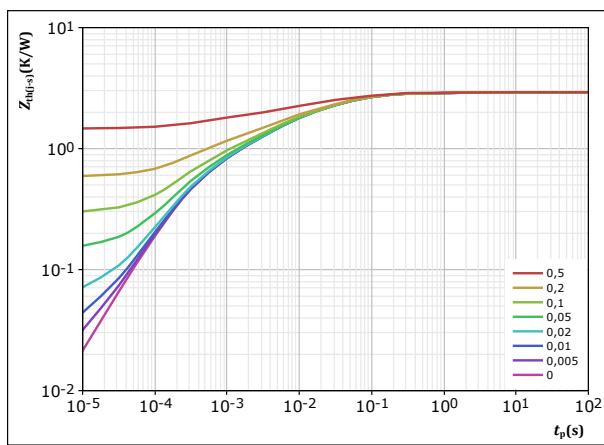
T_F :
— 25 °C
— 125 °C
— 150 °C

figure 17.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 2,925 \text{ K/W}$$

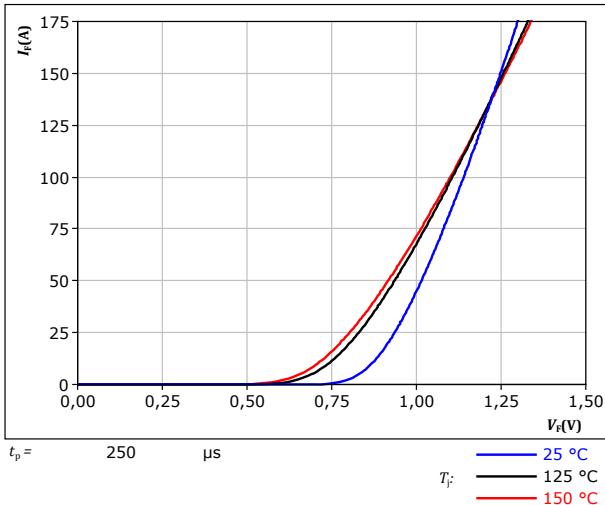
FWD thermal model values

R (K/W)	τ (s)
8,72E-02	1,61E+00
8,63E-01	6,27E-02
8,63E-01	9,50E-03
5,66E-01	2,17E-03
5,45E-01	3,02E-04



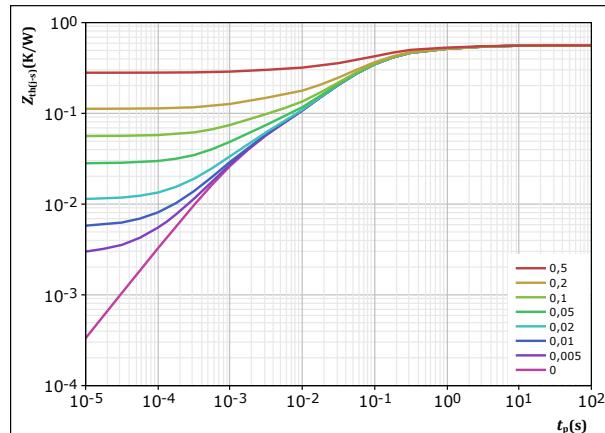
Rectifier Diode Characteristics

figure 18.
Typical forward characteristics
 $I_F = f(V_F)$



Rectifier

figure 19.
Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$

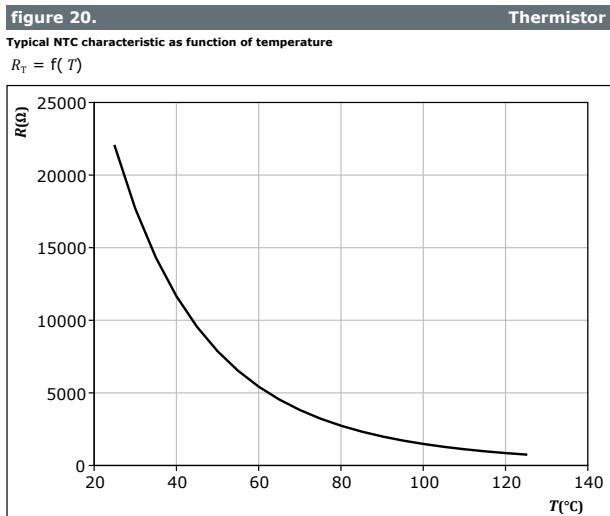


Rectifier

$D = t_p / T$	$R_{th(j-s)} = 0,561 \text{ K/W}$
	Rectifier thermal model values
$R \text{ (K/W)}$	$\tau \text{ (s)}$
3,37E-02	4,48E+00
8,84E-02	6,54E-01
3,02E-01	9,39E-02
1,00E-01	2,07E-02
3,73E-02	1,48E-03



Thermistor Characteristics





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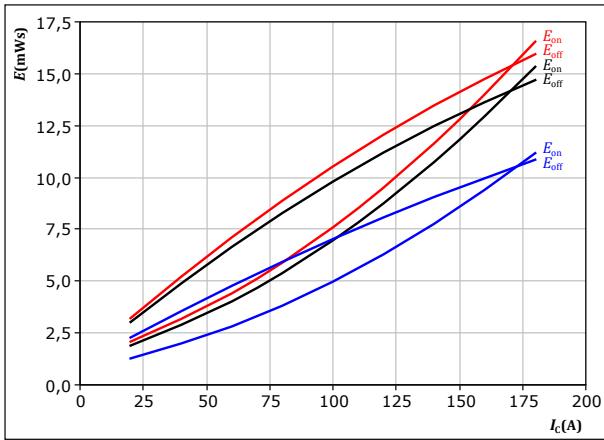
Inverter Switching Characteristics

figure 21.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

$V_{CE} =$	600	V
$V_{GE} =$	± 15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

$T_f:$ 25 °C

125 °C

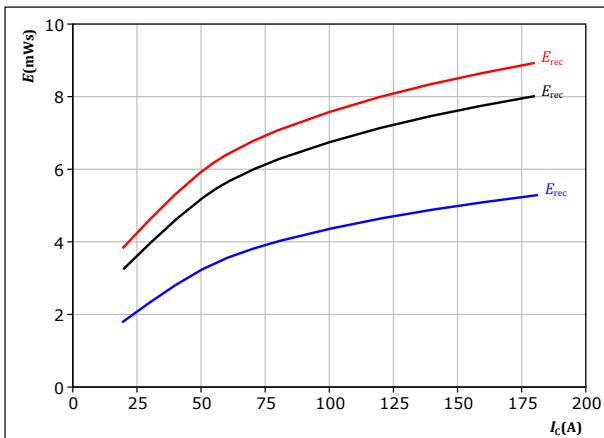
150 °C

figure 23.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

$V_{CE} =$	600	V
$V_{GE} =$	± 15	V
$R_{gon} =$	4	Ω

$T_f:$ 25 °C

125 °C

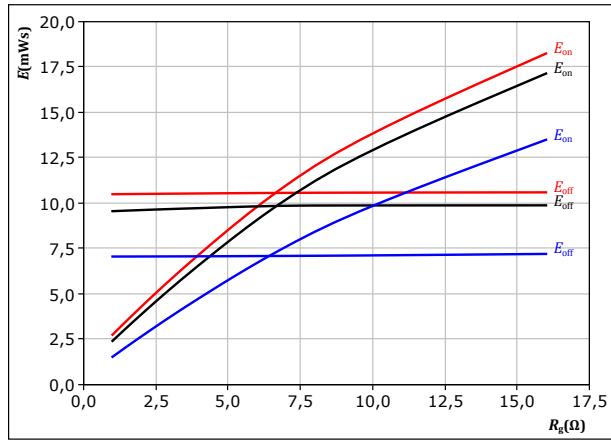
150 °C

figure 22.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} =$	600	V
$V_{GE} =$	± 15	V
$I_c =$	100	A

$T_f:$ 25 °C

125 °C

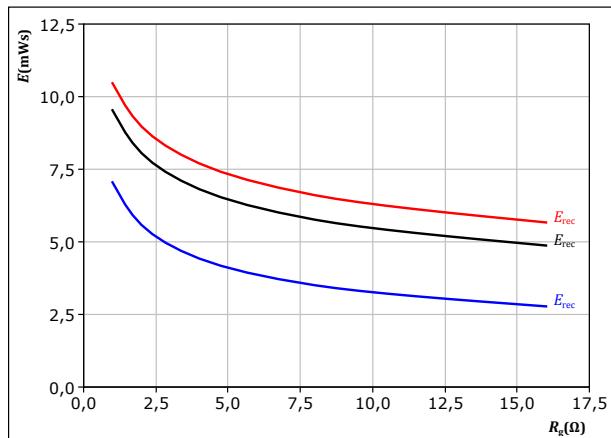
150 °C

figure 24.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} =$	600	V
$V_{GE} =$	± 15	V
$I_c =$	100	A

$T_f:$ 25 °C

125 °C

150 °C



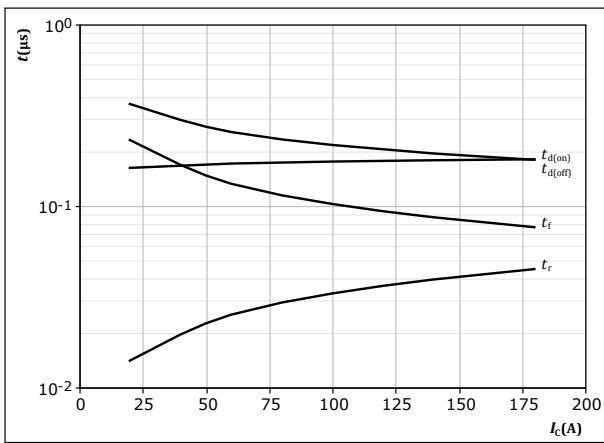
Vincotech

Inverter Switching Characteristics

figure 25.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$



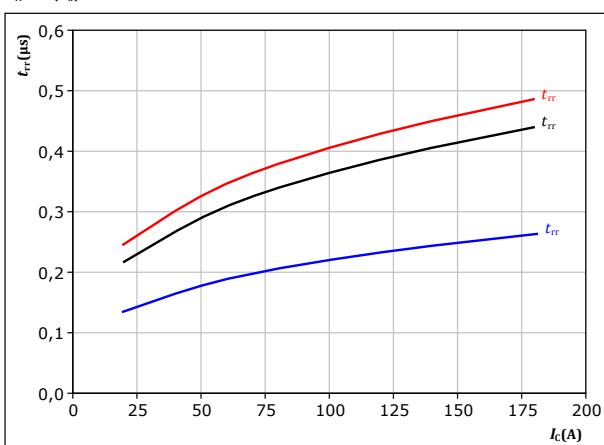
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \Omega$
 $R_{goff} = 4 \Omega$

figure 27.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



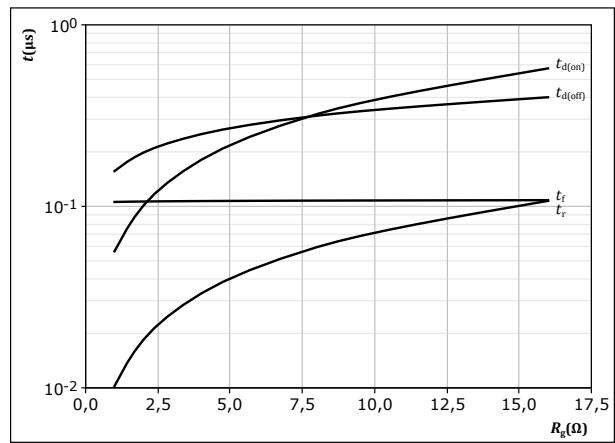
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \Omega$

figure 26.

IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$



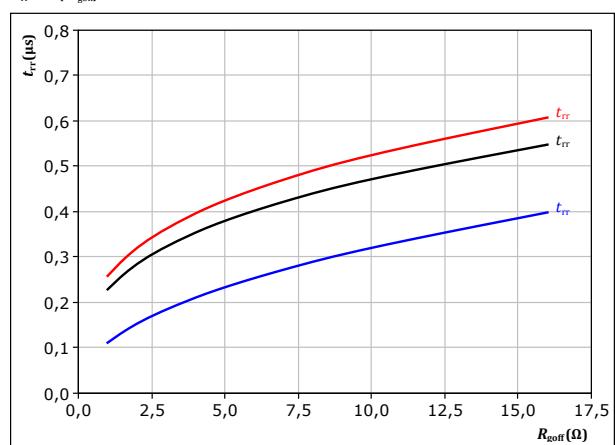
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 100 \text{ A}$

figure 28.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 100 \text{ A}$



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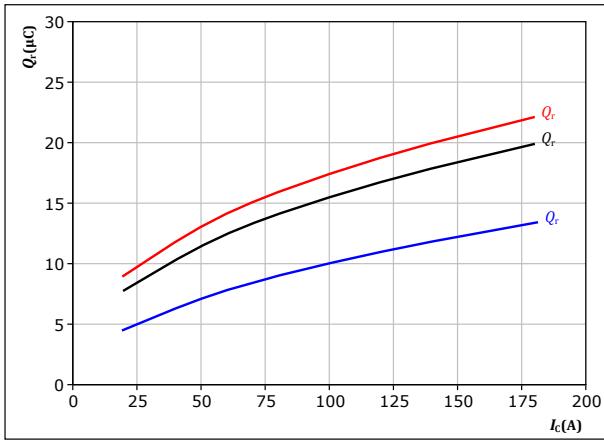
Inverter Switching Characteristics

figure 29.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \end{aligned}$$

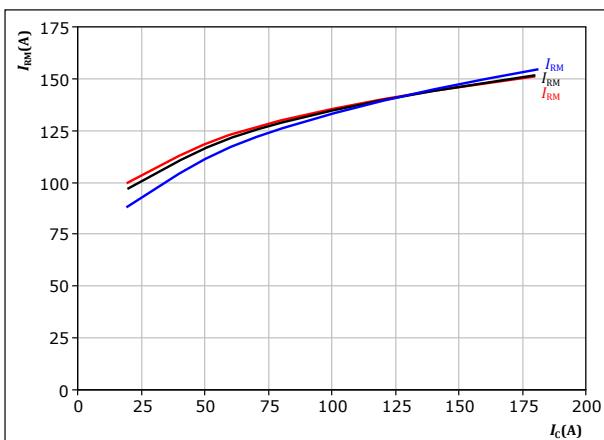
$$\begin{aligned} T_f: & \quad 25^\circ\text{C} \\ & \quad 125^\circ\text{C} \\ & \quad 150^\circ\text{C} \end{aligned}$$

figure 31.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \end{aligned}$$

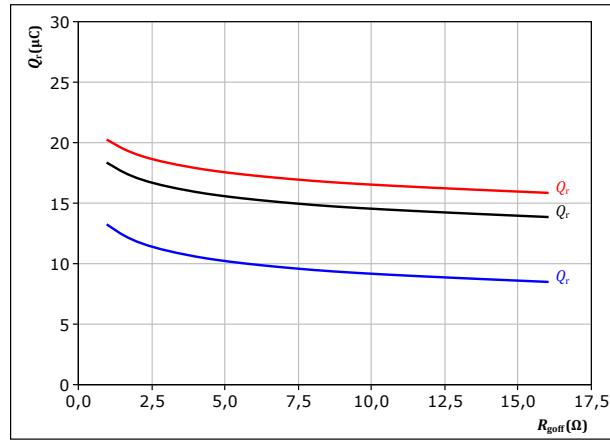
$$\begin{aligned} T_f: & \quad 25^\circ\text{C} \\ & \quad 125^\circ\text{C} \\ & \quad 150^\circ\text{C} \end{aligned}$$

figure 30.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 100 \quad \text{A} \end{aligned}$$

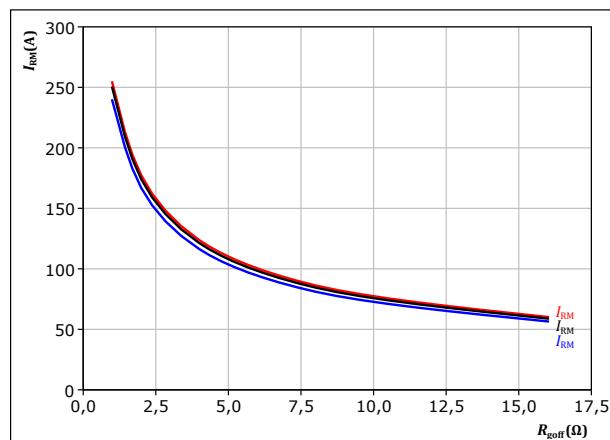
$$\begin{aligned} T_f: & \quad 25^\circ\text{C} \\ & \quad 125^\circ\text{C} \\ & \quad 150^\circ\text{C} \end{aligned}$$

figure 32.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goft})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 100 \quad \text{A} \end{aligned}$$

$$\begin{aligned} T_f: & \quad 25^\circ\text{C} \\ & \quad 125^\circ\text{C} \\ & \quad 150^\circ\text{C} \end{aligned}$$

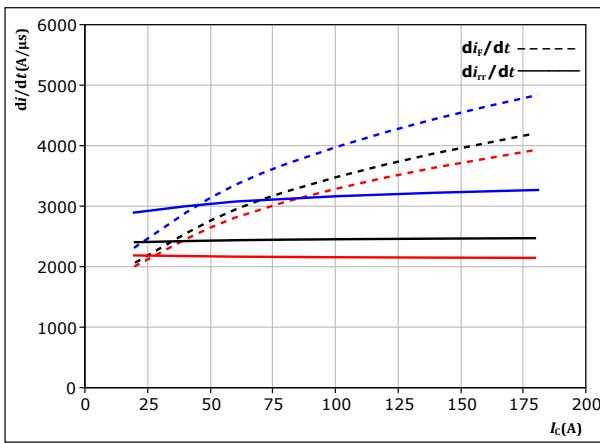


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Inverter Switching Characteristics

figure 33. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

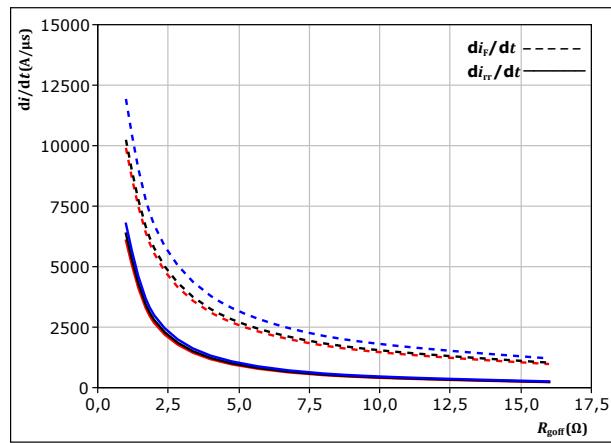


With an inductive load at

$V_{CE} = 600 \text{ V}$ $T_j = 25 \text{ }^\circ\text{C}$
 $V_{GE} = \pm 15 \text{ V}$ $T_j = 125 \text{ }^\circ\text{C}$
 $R_{gon} = 4 \Omega$ $T_j = 150 \text{ }^\circ\text{C}$

figure 34. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



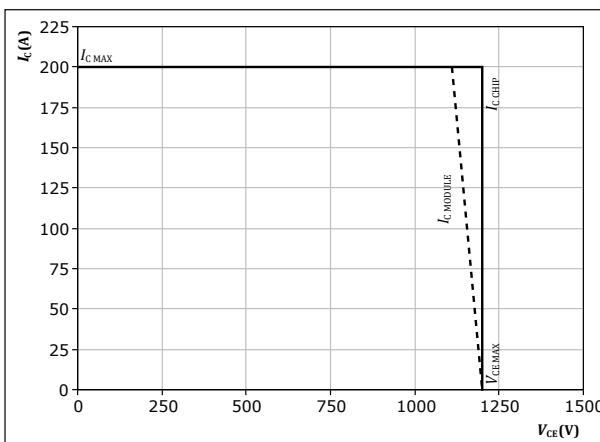
With an inductive load at

$V_{CE} = 600 \text{ V}$ $T_j = 25 \text{ }^\circ\text{C}$
 $V_{GE} = \pm 15 \text{ V}$ $T_j = 125 \text{ }^\circ\text{C}$
 $I_c = 100 \text{ A}$ $T_j = 150 \text{ }^\circ\text{C}$

figure 35. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150 \text{ }^\circ\text{C}$
 $R_{gon} = 4 \Omega$
 $R_{goff} = 4 \Omega$



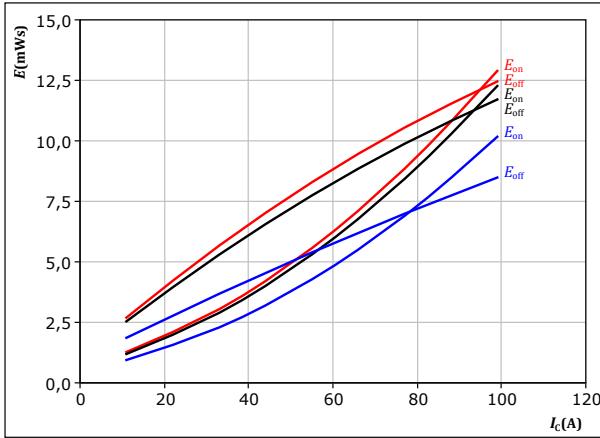
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Brake Switching Characteristics

figure 36. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

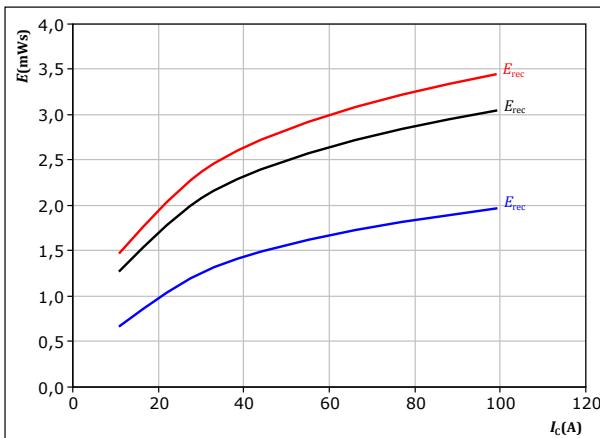
$V_{CE} =$	700	V
$V_{GE} =$	0/15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

$T_f:$ — 25 °C — 125 °C — 150 °C

figure 38. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

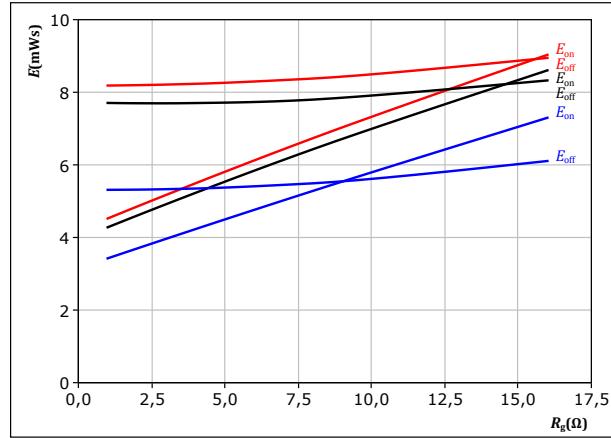
$V_{CE} =$	700	V
$V_{GE} =$	0/15	V
$R_{gon} =$	4	Ω

$T_f:$ — 25 °C — 125 °C — 150 °C

figure 37. IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

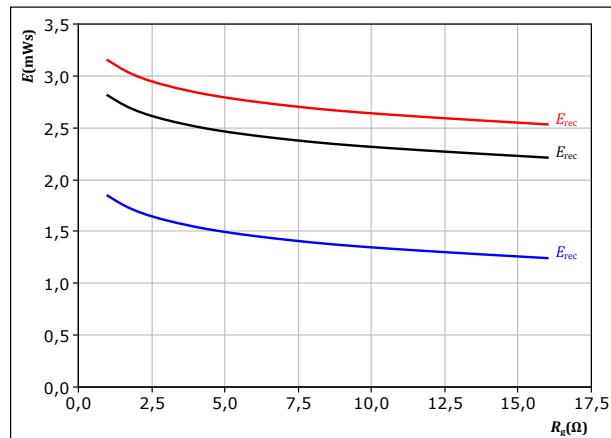
$V_{CE} =$	700	V
$V_{GE} =$	0/15	V
$I_c =$	55	A

$T_f:$ — 25 °C — 125 °C — 150 °C

figure 39. FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} =$	700	V
$V_{GE} =$	0/15	V
$I_c =$	55	A

$T_f:$ — 25 °C — 125 °C — 150 °C

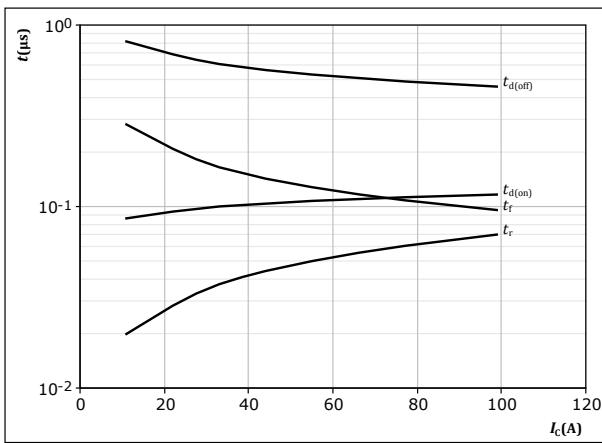


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Brake Switching Characteristics

figure 40.

Typical switching times as a function of collector current
 $t = f(I_C)$



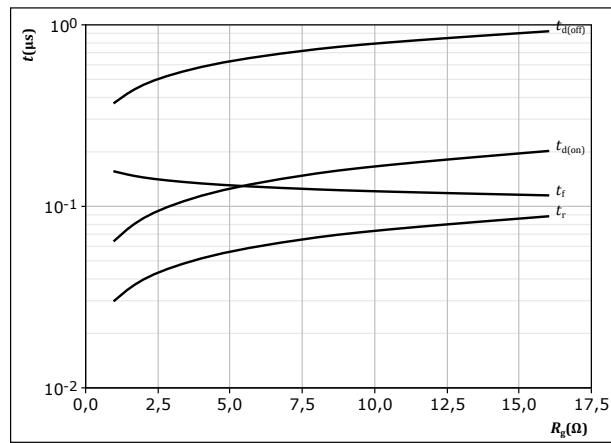
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 4 \Omega$
 $R_{goff} = 4 \Omega$

IGBT

figure 41.

Typical switching times as a function of gate resistor
 $t = f(R_g)$



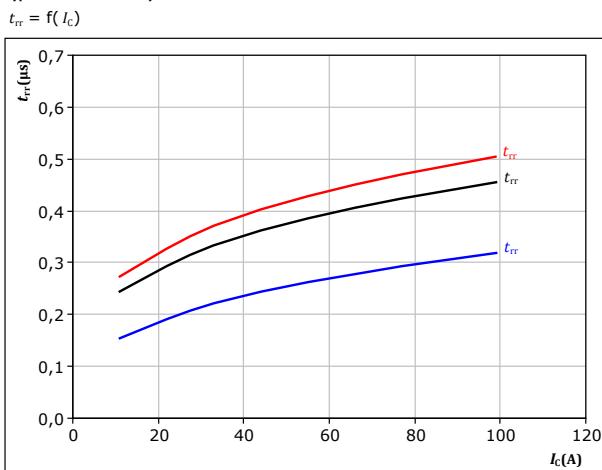
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_C = 55 \text{ A}$

IGBT

figure 42.

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



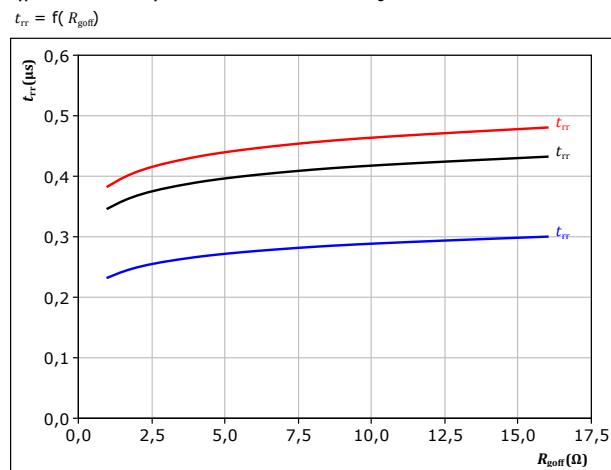
With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 4 \Omega$

FWD

figure 43.

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_C = 55 \text{ A}$

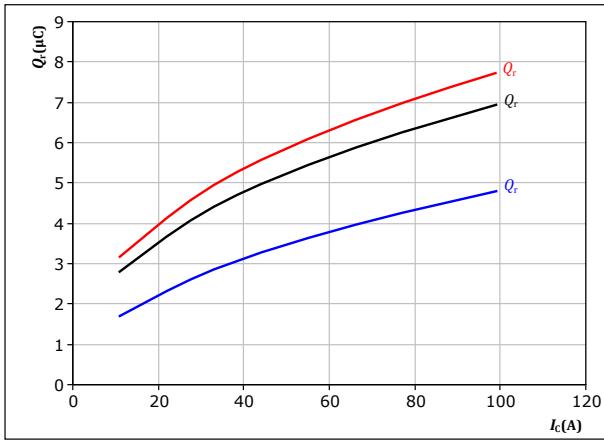
FWD

Brake Switching Characteristics

figure 44.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



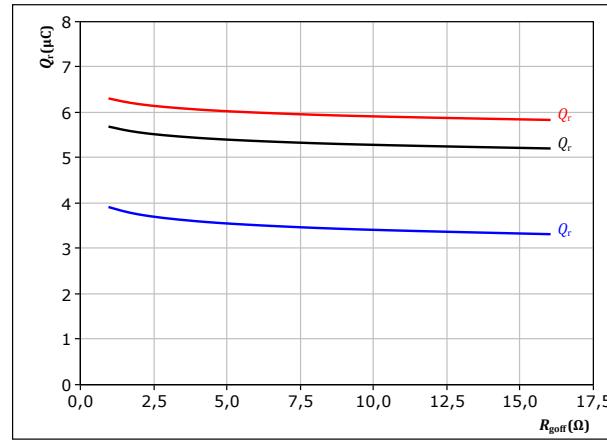
With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ R_{gon} &= 4 \Omega \end{aligned}$$

FWD
figure 45.

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{go\bar{n}})$$



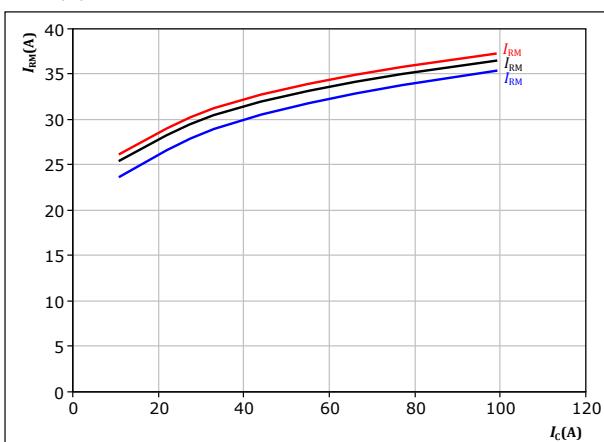
With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ I_c &= 55 \text{ A} \end{aligned}$$

FWD
figure 46.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



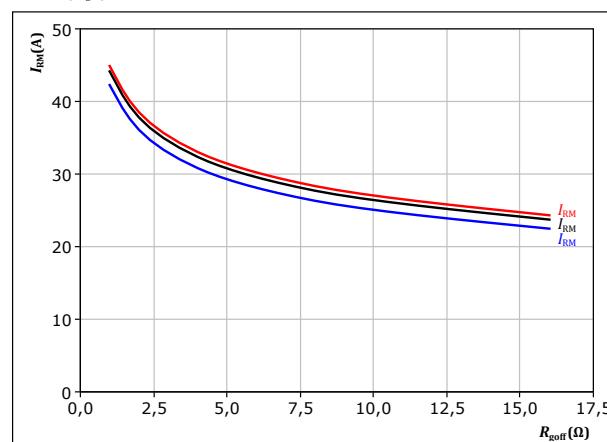
With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ R_{gon} &= 4 \Omega \end{aligned}$$

FWD
figure 47.

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{go\bar{n}})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ I_c &= 55 \text{ A} \end{aligned}$$

FWD



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Brake Switching Characteristics

figure 48. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

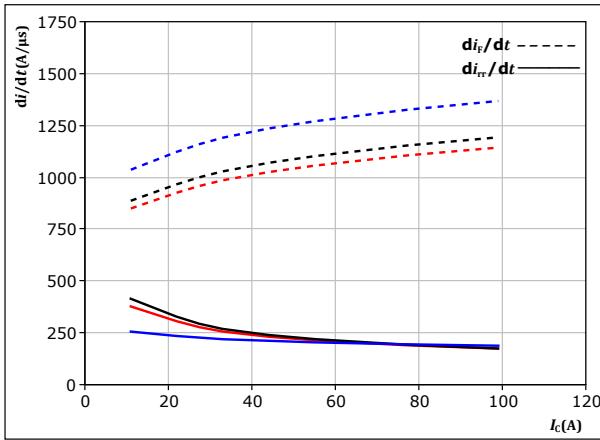


figure 49. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$

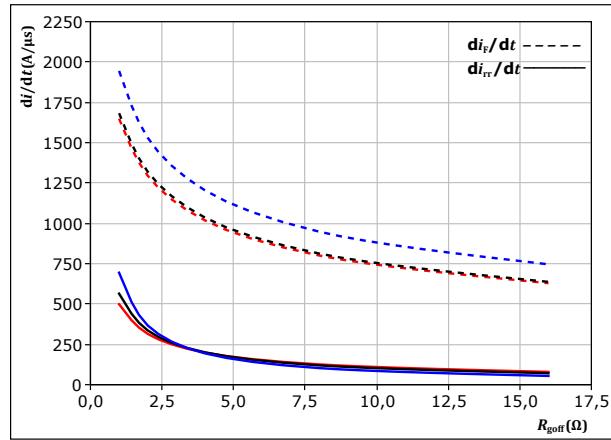
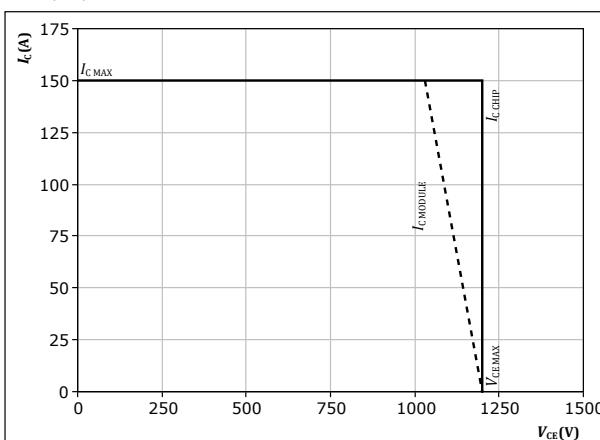


figure 50. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$





Vincotech

Switching Definitions

figure 51. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

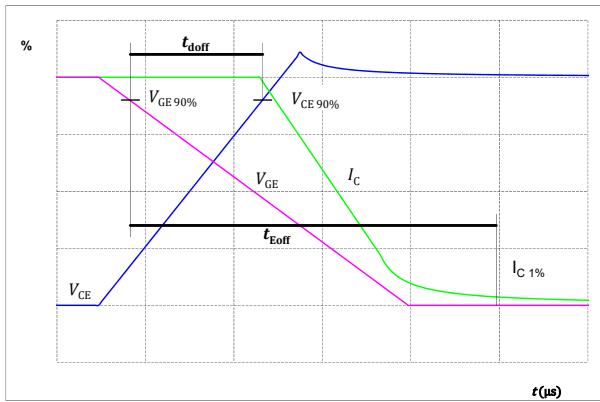


figure 52. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

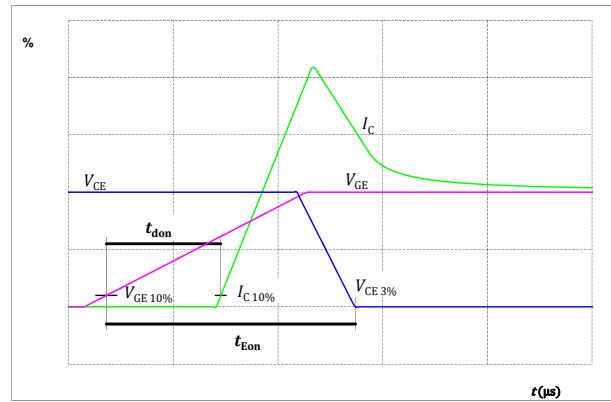


figure 53. IGBT

Turn-off Switching Waveforms & definition of t_f

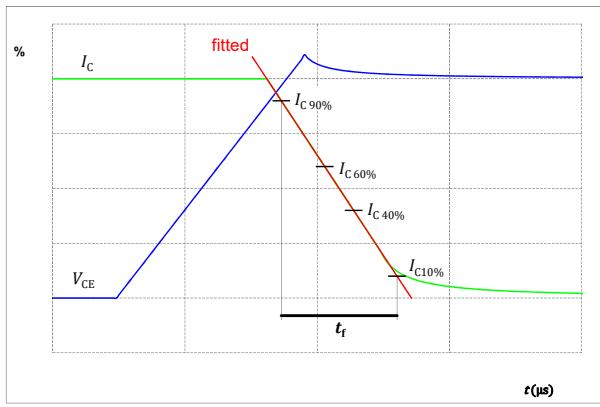
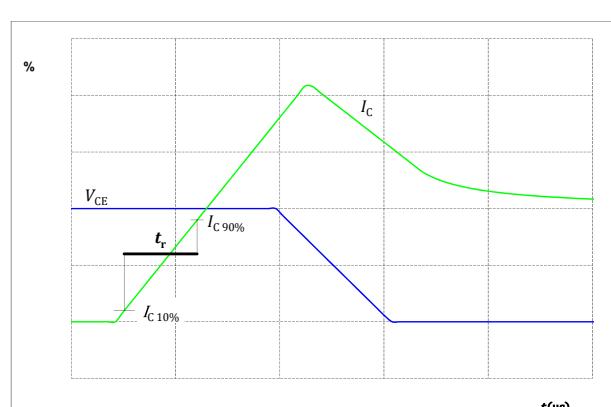


figure 54. IGBT

Turn-on Switching Waveforms & definition of t_r





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Switching Definitions

figure 55.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

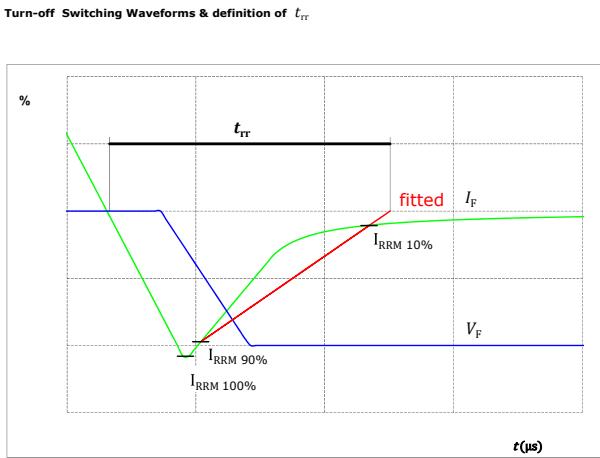
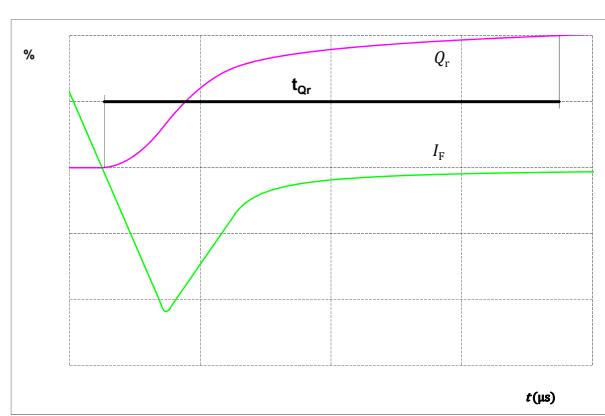


figure 56.

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD



**B0-SP12PMA100M7-LQ99A78T**

datasheet

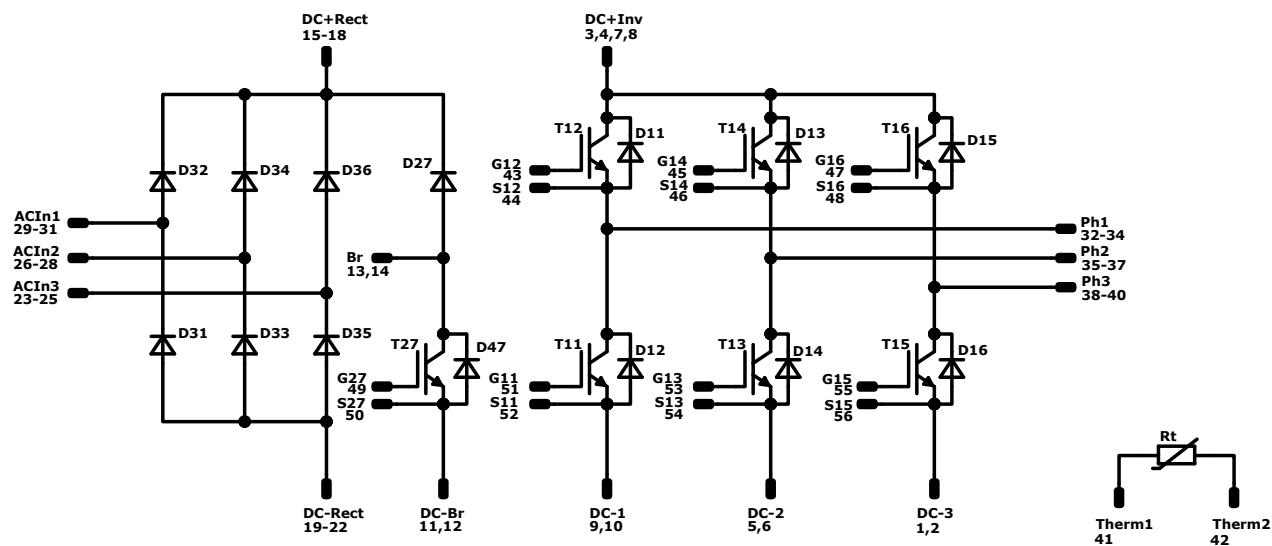
Vincotech

Ordering Code								
Version				Ordering Code				
With thermal paste (4,4 W/mK, PTM6000)				B0-SP12PMA100M7-LQ99A78T-/7/				
Marking								
NN-NNNNNNNNNNNNN TTTTVVVWWYY UL VIN LLLLLL SSSSS --- ---		Text	Name		Date code	UL & VIN	Lot	
			NN-NNNNNNNNNNNNN- TTTTVVV		WWYY	UL VIN	LLLLL	
Datamatrix		Type&Ver	Lot number	Serial	Date code		Serial	
		TTTTVVV	LLLLL	SSSS	WWYY			
Outline								
Pin table [mm]								
Pin	X	Y	Function	29	0	50,4	AcIn1	
1	52,4	0	DC-3	30	2,7	50,4	AcIn1	
2	49,7	0	DC-3	31	5,4	50,4	AcIn1	
3	42,75	8,85	DC+Inv	32	22,2	50,4	Ph1	
4	42,75	6,15	DC+Inv	33	24,9	50,4	Ph1	
5	37,35	0	DC-2	34	24,9	47,7	Ph1	
6	34,65	0	DC-2	35	34,45	50,4	Ph2	
7	29,2	8,85	DC+Inv	36	37,15	50,4	Ph2	
8	29,2	6,15	DC+Inv	37	36,9	47,7	Ph2	
9	23,95	0	DC-1	38	46,7	50,4	Ph3	
10	21,25	0	DC-1	39	49,4	50,4	Ph3	
11	16,8	0	DC-Br	40	48,4	47,7	Ph3	
12	14,1	0	DC-Br	41	52,4	38,95	Therm1	
13	6,9	0	Br	42	52,4	32,05	Therm2	
14	4,2	0	Br	43	27,9	50,4	G12	
15	0	10	DC+Rect	44	27,9	47,4	S12	
16	2,7	10	DC+Rect	45	40,15	50,4	G14	
17	0	7,3	DC+Rect	46	39,9	47,4	S14	
18	2,7	7,3	DC+Rect	47	52,4	50,4	G16	
19	0	20	DC-Rect	48	51,4	47,4	S16	
20	0	17,3	DC-Rect	49	16	6	G27	
21	2,7	17,3	DC-Rect	50	16	3	S27	
22	5,4	17,3	DC-Rect	51	20,85	25,05	G11	
23	3,5	28,3	AcIn3	52	22,65	22,05	S11	
24	6,2	28,3	AcIn3	53	39,85	24,6	G13	
25	8,9	28,3	AcIn3	54	36,85	22,05	S13	
26	3,5	39,35	AcIn2	55	52,4	24,6	G15	
27	6,2	39,35	AcIn2	56	49,4	22,05	S15	
28	8,9	39,35	AcIn2					



Vincotech

Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	1200 V	100 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1200 V	100 A	Inverter Diode	
T27	IGBT	1200 V	75 A	Brake Switch	
D27	FWD	1200 V	25 A	Brake Diode	
D47	FWD	1200 V	5 A	Brake Sw. Protection Diode	
D31, D32, D33, D34, D35, D36	Rectifier	1600 V	60 A	Rectifier Diode	
Rt	Thermistor			Thermistor	

**B0-SP12PMA100M7-LQ99A78T**

datasheet

Vincotech**Packaging instruction**

Standard packaging quantity (SPQ) 45	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow S3 packages see vincotech.com website.

Package data

Package data for flow S3 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
B0-SP12PMA100M7-LQ99A78T-D1-14	25 Jan. 2021		
B0-SP12PMA100M7-LQ99A78T-D2-14	4 Aug. 2021	Module marking is updated with UL logo, product is unchanged	

DISCLAIMER

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As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.